

**Microchip****Filter specification****TFS 733****1/5****Measurement condition**

|                        |      |     |
|------------------------|------|-----|
| Ambient temperature:   | 23   | °C  |
| Input power level:     | 0    | dBm |
| Terminating impedance: |      |     |
| Input:                 | 50 Ω |     |
| Output:                | 50 Ω |     |

**Characteristics**

## Remark:

The maximum attenuation in the pass band is defined as the insertion loss  $a_p$ . The nominal frequency  $f_N$  is fixed at 733MHz without any tolerance or limit. The values of absolute attenuation  $a_{abs}$  are guaranteed for the whole operating temperature range. The frequency shift of the filter in the operating temperature range is included in the production tolerance scheme.

| <b>D a t a</b>                                  |                  | <b>typ. value</b> |           | <b>tolerance / limit</b> |                    |     |
|-------------------------------------------------|------------------|-------------------|-----------|--------------------------|--------------------|-----|
| <b>Insertion loss</b>                           |                  | $a_p$             | 1.5 dB    | max.                     | 3.0                | dB  |
| <b>Nominal frequency</b>                        |                  | $f_N$             |           |                          | 733.0              | MHz |
| <b>Passband</b>                                 |                  | PB                |           | $f_N \pm$                | 5.0                | MHz |
| <b>Pass band variation</b>                      |                  |                   | 0.4 dB    | max.                     | 0.8                | dB  |
| <b>Absolute attenuation</b>                     |                  | $a_{abs}$         |           |                          |                    |     |
| 10                                              | MHz ... 200 MHz  |                   | 38 dB     | min.                     | 20                 | dB  |
| 200                                             | MHz ... 550 MHz  |                   | 34 dB     | min.                     | 15                 | dB  |
| 816                                             | MHz ... 905 MHz  |                   | 38 dB     | min.                     | 5                  | dB  |
| 905                                             | MHz ... 1073 MHz |                   | 37 dB     | min.                     | 20                 | dB  |
| 1073                                            | MHz ... 1085 MHz |                   | 42 dB     | min.                     | 33                 | dB  |
| 1085                                            | MHz ... 1480 MHz |                   | 39 dB     | min.                     | 15                 | dB  |
| 1480                                            | MHz ... 2690 MHz |                   | 23 dB     | min.                     | 10                 | dB  |
| 2690                                            | MHz ... 4900 MHz |                   | 15 dB     | min.                     | 10                 | dB  |
| <b>Group delay ripple within PB</b>             |                  | p-p               | 13 ns     | max.                     | 50                 | ns  |
| <b>Absolute group delay at <math>f_N</math></b> |                  |                   | 35 ns     | max.                     | 100                | ns  |
| <b>Return loss within PB</b>                    |                  |                   | 16 dB     | min.                     | 14                 | dB  |
| <b>Input power level</b>                        |                  |                   |           | max.                     | 16                 | dBm |
| <b>Operating temperature range</b>              |                  | OTR               | -         |                          | - 40 °C ... + 85°C |     |
| <b>Storage temperature range</b>                |                  |                   | -         |                          | - 40 °C ... + 85°C |     |
| <b>Temperature coefficient of frequency</b>     |                  | $TC_f$ *          | -42 ppm/K |                          |                    |     |

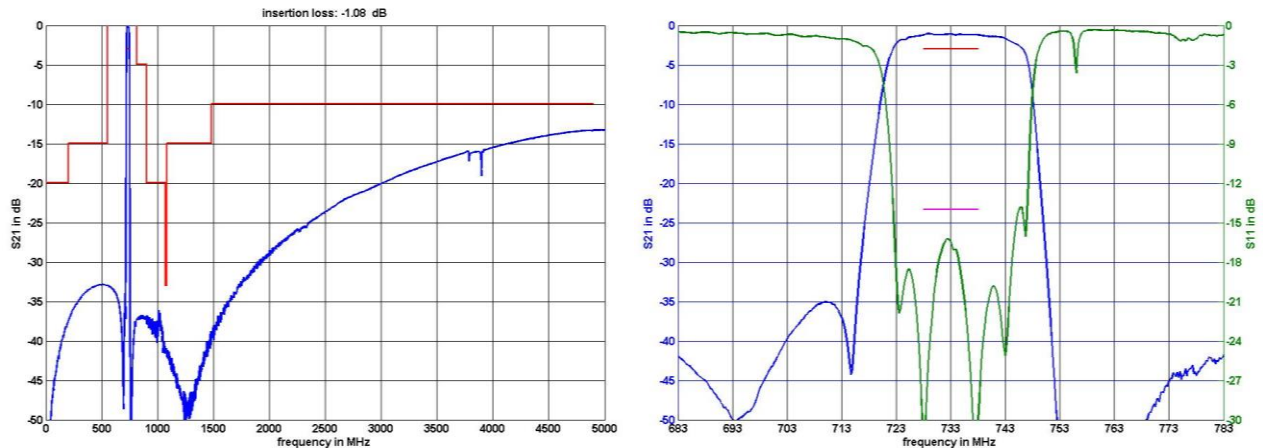
\*)  $\Delta f_c(\text{Hz}) = TC_f(\text{ppm/K}) \times (T - T_0) \times f_{CAT}(\text{MHz})$

**Generated:****Checked / Approved:**

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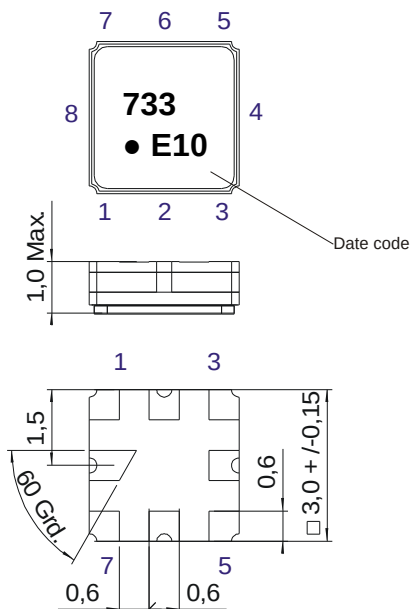
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## Filter characteristic



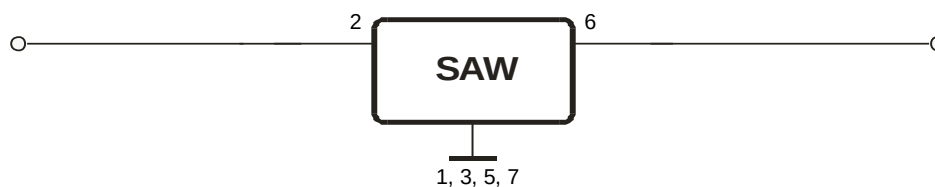
## Construction and pin connection

(All dimensions in mm)



|   |          |
|---|----------|
| 1 | Ground   |
| 2 | Input    |
| 3 | Ground   |
| 4 | Floating |
| 5 | Ground   |
| 6 | Output   |
| 7 | Ground   |
| 8 | Floating |

Date code: Year + week  
 E 2014  
 F 2015  
 G 2016  
 ...

50  $\Omega$  Test circuit

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**Stability characteristics, reliability**

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 1 ms, half sine wave, 3 shocks each plane;  
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0.35 mm or g respectively, 1 octave per min, 10 cycles per plane, 3 planes; DIN IEC 68 T2 - 6
3. Change of temperature: -55 °C to 125°C / 15 min. each / 100 cycles  
DIN IEC 68 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: three times max.;  
for temperature conditions, see page 4: "Air reflow temperature conditions"

This filter is RoHS compliant (2011/65/EU)

**Packing**

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;  
tape type II, embossed carrier tape with top cover tape on the upper side;

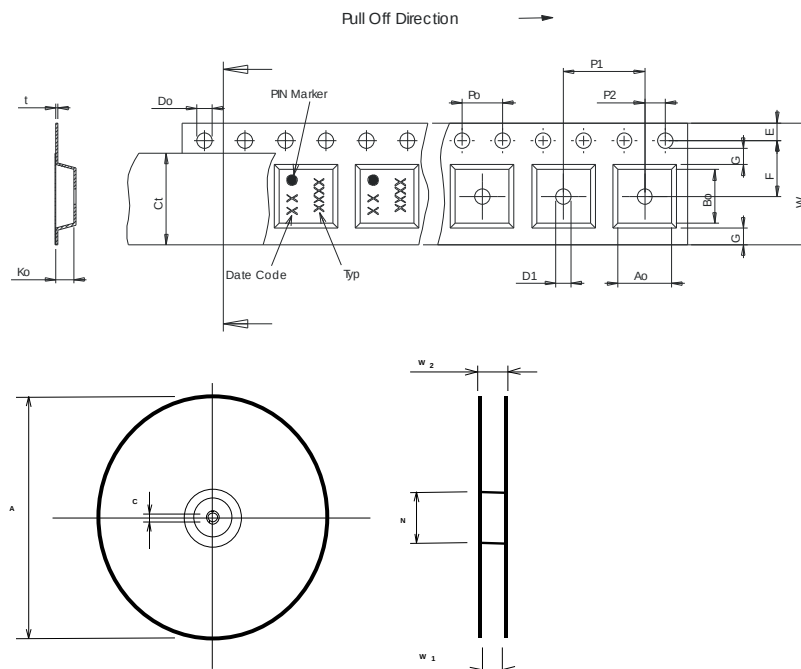
max. pieces of filters per reel: 3000  
reel of empty components at start: min. 300 mm  
reel of empty components at start including leader: min. 500 mm  
trailer: min. 300 mm

**Tape (all dimensions in mm)**

|         |                |
|---------|----------------|
| W       | : 12.00 ± 0.3  |
| Po      | : 4.00 ± 0.1   |
| Do      | : 1.55 +0.1/-0 |
| E       | : 1.75 ± 0.1   |
| F       | : 5.50 ± 0.05  |
| G(min)  | : 0.75         |
| P2      | : 2.00 ± 0.05  |
| P1      | : 4.00 ± 0.1   |
| D1(min) | : 1.50         |
| Ao      | : 3.25 ± 0.1   |
| Bo      | : 3.25 ± 0.1   |
| Ct      | : 9.2 ± 0.1    |

**Reel (all dimensions in mm)**

|         |                |
|---------|----------------|
| A       | : 180.0        |
| W1      | : 12.4 +1.5/-0 |
| W2(max) | : 18.4         |
| N(min)  | : 60.0         |
| C       | : 13.0 ± 0.2   |



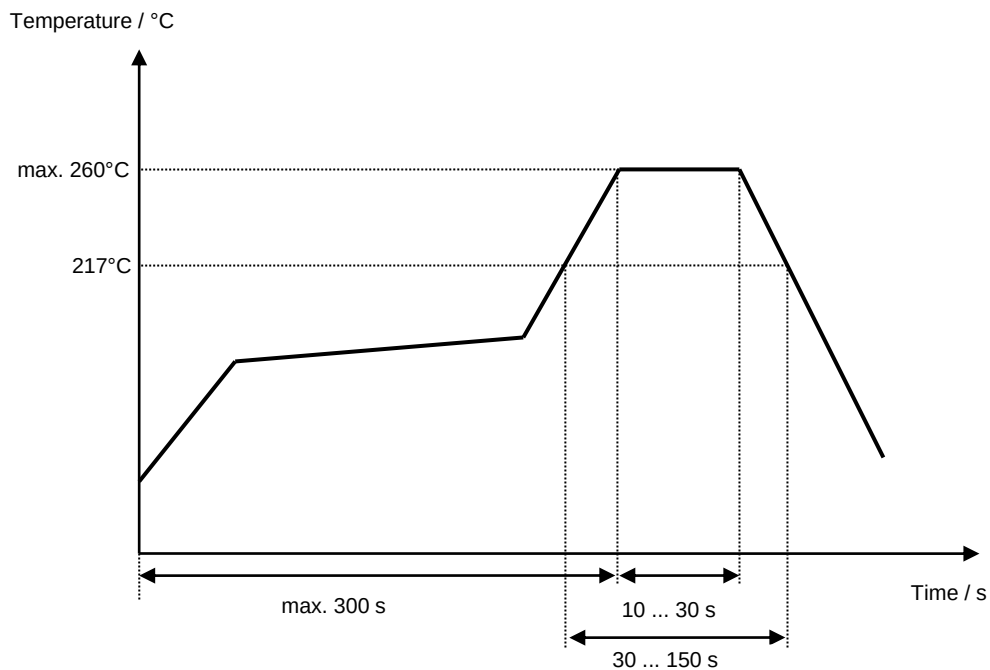
The minimum bending radius is 45 mm.

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**Air reflow temperature conditions**

| <b>Conditions</b>                          | <b>Exposure</b>             |
|--------------------------------------------|-----------------------------|
| Average ramp-up rate (30°C to 217°C)       | less than 3°C/second        |
| > 100°C                                    | between 300 and 600 seconds |
| > 150°C                                    | between 240 and 500 seconds |
| > 217°C                                    | between 30 and 150 seconds  |
| Peak temperature                           | max. 260°C                  |
| Time within 5°C of actual peak temperature | between 10 and 30 seconds   |
| Cool-down rate (Peak to 50°C)              | less than 6°C/second        |
| Time from 30°C to Peak temperature         | no greater than 300 seconds |

**Chip-mount air reflow profile**

**Microchip****Filter specification****TFS 733****5/5****History**

| <b>Version</b> | <b>Reason of Changes</b>                                                             | <b>Name</b>   | <b>Date</b> |
|----------------|--------------------------------------------------------------------------------------|---------------|-------------|
| 1.0            | Generation of development specification.                                             | S.Springfeldt | 21.09.2012  |
| 2.0            | Change of package (6pad to 8pad with floating pins)<br>Change of data table @4900MHz | S.Springfeldt | 04.01.2013  |
| 2.1            | Generation of filter specification                                                   | S.Springfeldt | 07.01.2013  |
| 2.2            | Updating plots and typical values                                                    | S.Springfeldt | 04.07.2013  |
| 3.0            | Change of tape and reel width from 8mm to 12mm                                       | S.Springfeldt | 23.10.2013  |
| 3.1            | maximum input power updated                                                          | Kortenbeutel  | 07.01.2014  |
| 3.2            | Adding tape and reel dimensions                                                      | S.Springfeldt | 06.03.2014  |